

Refine Search

Search Results -

| Terms | Documents |
|------------------------------|-----------|
| L2 and (stop? near2 polymer) | 1 |

Database:

US Pre-Grant Publication Full-Text Database
 US Patents Full-Text Database
 US OCR Full-Text Database
 EPO Abstracts Database
 JPO Abstracts Database
 Derwent World Patents Index
 IBM Technical Disclosure Bulletins

Search:

L3

Refine Search

Recall Text



Clear

Interrupt

Search History

DATE: Monday, March 22, 2004 [Printable Copy](#) [Create Case](#)

Set Name Query

side by side

DB=USPT; PLUR=YES; OP=ADJ

Hit Count Set Name

result set

| | | | |
|-----------|---|------|-----------|
| <u>L3</u> | L2 and (stop? near2 polymer) | 1 | <u>L3</u> |
| <u>L2</u> | L1 and cmp | 1269 | <u>L2</u> |
| <u>L1</u> | (polishing or polish) near2 (stop or stopper) | 1869 | <u>L1</u> |

END OF SEARCH HISTORY

Hit List

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| Generate OACS | | | | |

Search Results - Record(s) 1 through 2 of 2 returned.

☐ 1. Document ID: US 6417116 B2

L4: Entry 1 of 2

File: USPT

Jul 9, 2002

US-PAT-NO: 6417116

DOCUMENT-IDENTIFIER: US 6417116 B2

TITLE: Semiconductor device having a multilayer interconnection structure

| Full | Title | Citation | Front | Review | Classification | Date | Reference | | | Claims | RMC | Draw Dc |
|------|-------|----------|-------|--------|----------------|------|-----------|--|--|--------|-----|---------|
|------|-------|----------|-------|--------|----------------|------|-----------|--|--|--------|-----|---------|

☐ 2. Document ID: US 6383933 B1

L4: Entry 2 of 2

File: USPT

May 7, 2002

US-PAT-NO: 6383933

DOCUMENT-IDENTIFIER: US 6383933 B1

TITLE: Method of using organic material to enhance STI planarization or other planarization processes

| Full | Title | Citation | Front | Review | Classification | Date | Reference | | | Claims | RMC | Draw Dc |
|------|-------|----------|-------|--------|----------------|------|-----------|--|--|--------|-----|---------|
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| Clear | Generate Collection | Print | Fwd Refs | Bkwd Refs | Generate OACS |
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| Terms | Documents |
|---|-----------|
| L2 and ((organic or polymer) near2 (stop?)) | 2 |

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Hit List

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| Generate OACS | | | | |

Search Results - Record(s) 1 through 1 of 1 returned.

☐ 1. Document ID: US 6383933 B1

L3: Entry 1 of 1

File: USPT

May 7, 2002

US-PAT-NO: 6383933

DOCUMENT-IDENTIFIER: US 6383933 B1

TITLE: Method of using organic material to enhance STI planarization or other planarization processes

| Full | Title | Citation | Front | Review | Classification | Date | Reference | | | Claims | KMC | Draw D |
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| Terms | Documents |
| L2 and (stop? near2 polymer) | 1 |

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